

## Statement of Compliance

**Requested Part** 

04 September 2017	1367073-1		(Part 1 of 1)
20 POS SMT CONN, SFP, 15AU			
	Part Status:	Active	
	Mil-Spec Certified:	No	
	EU RoHS:	Compliant	
	EU ELV:	Compliant	
	China RoHS:	No Restricted Materials Above	Threshold
	EU REACH SvHC Compliance:	Regulation (EC) No. 1907/2006	
		Current ECHA Candidate List: JUL	2017
		Candidate List Declared Against: Jl	JL 2017
		Does not contain REACH SvHCs	
	Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppr material. Also BFR/CFR/PVC Free	m per homogenous
	Solder Process Capability Code:	Reflow solder capable to 260°C	
	Material Declarations:	MD_1367073-1	
TE Connectivity Corneration			

**TE Connectivity Corporation** 

1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SvHCs in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach